Maruyama et al.

[45] Mar. 26, 1974

[54]	PHOTOCO IMAGE T	ONDUCTIVE TARGET OF AN UBE	3,127,545 3,130,137	3/1964 4/1964	Zloczower
[75]	Inventors:	Eiichi Maruyama, Kodaira; Tadaaki Hirai, Koganei; Kiyohisa Inao, Hachioji; Naohiro Goto, Machida, all of Japan	3,711,719 3,590,253 3,755,002	1/1973 6/1971 8/1973	Szepesi 250/213 R Novice 250/213 Hirai et al 148/1.5
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[22]	Filed:	Apr. 4, 1973			
[21]	Appl. No.:	347,663	[57]		ABSTRACT
[30]	Foreign Apr. 7, 1972	Application Priority Data 2 Japan	transmitting	g conduct	e pickup tube comprising a light- tive layer supported on a light-
[52]	U.S. Cl 3	17/235 R, 317/235 N, 317/235 NA, 317/235 AC, 317/241	with rectify	substrat	e and a photoconductive layer of at least at one of its sides in
[51]	Int. Cl	H011 15/00: 250/213	A or thick	notoconc	luctive layer has a portion 1,000
[58]	Field of Sea	arch 317/235 N, 235 AC, 241, 317/234 S, 235 NA; 313/66	photocondu	or more ctive cha	comprises a multiplicity of thin different materials with different racteristics, each having a thick-
[56]	UNIT	References Cited ED STATES PATENTS	ness of not	more thar	100 A, the thin films of the dif- g laid alternately one on another.
3,439,2	240 4/196	9 Geib, Jr 317/241		6 Claims	, 6 Drawing Figures

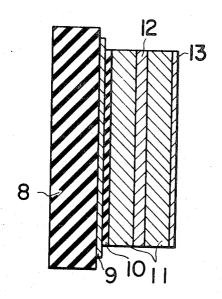


FIG. I

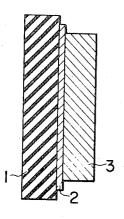
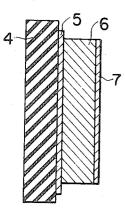
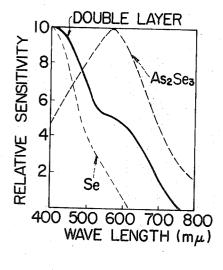


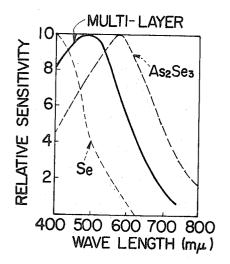
FIG. 4



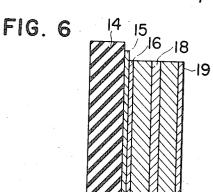








12 FIG. 5



PHOTOCONDUCTIVE TARGET OF AN IMAGE TUBE

The present invention relates to a target of an image pickup tube or more in particular to a target of an image pickup tube of vidicon type utilizing the rectifying contact of a photoconductive semiconductor.

The materials of the target for the image pickup tube now in commercial use include photoconductive semiconductors such as Sb₂S₃, PbO and Si. A target of Sb₂S₃ 10 is characterized by an ohmic contact, while those made of PbO or Si generally have a rectifying contact or is of a PN junction type. The target with the rectifying contact or PN junction has many advantages including sensitivity and greater in response speed than the target with an ohmic contact. The manufacture of an image pickup tube with a PN junction of single crystal such as a vidicon with Si target requires highly complex processes, and also it is very difficult to remove an imper- 20 fection of a picture attributable to the defects of a crystal bulk or unsatisfactory processes. A target of a thin film with a rectifying contact, by comparison, is manufactured by comparatively simple processes, but it is not an easy matter to achieve a rectifying contact 25 which is used successfully for a vidicon target, the known materials suitable for such a purpose being limited to PbO and few others including selenium and its compounds.

Further, in the conventional co-evaporation method 30 of forming an evaporated thin film of a compound semiconductor with a desirable sensitive spectral region by controlling its composition, a plurality of different component elements are deposited simultaneously from a plurality of sources of evaporation. In such a 35 method, however, the plurality of sources are located at different positions relative to the substrate and therefore the composition of the resulting layer on the substrate is not necessarily uniform at every point on the substrate.

For the above mentioned reasons, it is difficult in the conventional methods to obtain a thin film with a rectifying contact by evaporation which fully meet, all the requirements of an image pickup tube including a superior dark current characteristic, spectral sensitivity 45 characteristic and after image.

The inventors have discovered that the alternate deposition of a multiplicity of thin films of different substances one on another makes it possible to obtain a photoconductive layer with a photoconductive characteristic quite similar to that of a material resulting from the uniform mixing of such substances. Generally, when a plurality of thin films with different photoconductive characteristics are laid one on another, the resulting characteristic is the sum of the different photoconductive characteristics involved. If, however, the thickness of each component thin film is sufficiently small and the laminated structure consists of a multiplicity of such thin films deposited alternately one on another, the resulting photoconductive characteristic is intermediate with respect to those of the component thin films.

Accordingly, it is an object of the present invention to obviate the disadvantages of the conventional target of an image pickup tube and to provide a novel target of an image pickup tube which is capable of controlling the spectral sensitivity characteristic of the image

pickup tube considerably without adversely affecting its characteristics of dark current and after image.

In order to achieve the above mentioned object, the target of the image pickup tube according to the present invention comprises a light-transmitting substrate, a light-transmitting conductive layer and a photoconductive layer deposited on the light-transmitting conductive layer and including a part 1,000 A or thicker consisting of at least two thin films of different photo-conductive characteristics alternately laid one on another, each of the thin films being 100 A or thinner said photo-conductive layer having at least one rectifying contact on its surface.

The above and other objects, features and advanthe fact that they allow less dark current, is higher in 15 tages will be made apparent by the detailed description taken in conjunction with the accompanying drawings, in which:

> FIG. 1 is a diagram showing a section of a target for the image pickup tube according to the present inven-

> FIG. 2 is a diagram showing the spectral sensitivity of a conventional photo-conductive double layer consisting of Se and As₂S₃;

FIG. 3 is a diagram showing the spectral sensitivity of a layer consisting of Se and As₂S₃ used for the target for the image pickup tube according to the present invention; and

FIGS. 4 to 6 are diagrams showing sections of embodiments of the present invention.

EMBODIMENT 1

An embodiment of the invention is illustrated in FIG. 1, in which reference numeral 1 shows a glass substrate, numeral 2 a light-transmitting conductive layer, and numeral 3 a photo-conductive layer. The photoconductive layer 3 of about 3 microns thick is made by depositing by evaporation a multiplicity of selnium films each about 20 A and As₂Se₃ films each about 7 A alternately one on another in a vacuum of 5×10^{-6} Torr. A rectifying contact is formed between the lighttransmitting conductive layer 2 and the photoconductive layer 3. A photo-conductive layer 3 consisting of only a selenium film has a superior rectifying contact but has the disadvantage of insufficient sensitivity to light of long wavelength. When the photo-conductive layer 3 is formed of only As₂Se₃, by contrast, a high sensitivity to red light is obtained but it is impossible to form a superior rectifying contact.

In case the photo-conductive layer 3 were made of comparatively thick Se and As₂Se₃ films of, say, 5,000 A each, two peaks of spectral sensitivity corresponding to those of the individual component films of Se and As₂Se₃ respectively would be observed as shown in FIG. 2. The photo-conductive layer 3 according to the present invention, by contrast, which comprises a multiplicity of comparatively thin Se and As₂Se₃ alternate films of, say, 50 A in thickness each having its peak of spectral sensitivity intermediate with respect to the two hypothetical peaks which otherwise might occur separately for the two component film elements. In the latter case, it is considered that the photo-conductive layer 3 has similar characteristics as if Se and As₂Se₃ are mixed uniformly. Such similarity is achieved only when the thickness of each film of Se and As₂Se₃ is approximately 100 A or less.

Further, it is possible by employing the construction of the photo-conductive layer according to this em3

bodiment to achieve a photo-conductive layer superior in dark current characteristic, after image characteristic and sensitivity to long wavelength light as shown in Table 1 without adversely affecting the rectifying characteristic.

TABLE 1 — Characteristics of Target for Image Pickup Tube According to Embodiment 1

target construc- tion	dark current at target voltage of 50 V	wavelength at peak spectral sensitivity	lag (after 3 fields)	after image
only As ₂ Se ₃	l nA	$400~\mathrm{m}\mu$	6%	long
only this in-	20 nA	580 mμ	50%	very long
vention	1 nA	520 mμ	6%	short

Furthermore, although in the above embodiment the different types of film may be employed, more than three different types of films may be deposited one on 20 another to obtain the photo-conductive layer according to the invention by using as many evaporation sources. Also, it is possible to achieve any desired mixing ratio by varying the thickness of each film accordingly.

For the practical purpose of controlling the spectral 25 sensitivity of the photo-conductive layer the above mentioned multi-layer construction is not necessarily required all over its total thickness. Most of the energy of light entering the photo-conductive layer is absorbed at its portion within the depth of several thousands of A from the surface thereof. Therefore, the portion of the layer as thick as 1,000 A or more from the surface has a controlling effect upon the spectral sensitivity of the photo-conductive layer.

If the photo-conductive layer with the above men- 35 tioned construction is to be used for a target of the image pickup tube, its dark current characteristic, after image characteristic, lag characteristic as well as the spectral sensitivity are required to be maintained at a satisfactory level for the image pickup tube. It is already mentioned that a desirable construction for the target of an image pickup tube is of the rectifying contact type. Since the characteristic of the target of the rectifying contact type largely depends upon the shape of the rectifying barrier, the portion of the photoconductive multi-layer for controlling the spectral sensitivity must be so selected as not to adversely affect the other characteristics of the photo-conductive layer. To achieve maximum utilization of incident light, it is recommended that the multi-layer portion of the photoconductive layer be located as near to the plane of incidence as possible so far as the effect of the rectifying barrier is not reduced.

The photo-conductive layer used as a target for an image pickup tube generally has the thickness of 2 to 20 microns, and it is possible, by providing a portion of the photo-conductive layer as thick as 1,000 A for controlling the spectral sensitivity of the photo-conductive layer, to limit the function of such portion to the controlling of the spectral sensitivity without any substantial effect upon the lag, after image and dark current characteristics of the photo-conductive layer.

EMBODIMENT 2

Referring to FIG. 4 showing another embodiment of the invention, reference numeral 4 denotes a glass substrate, numeral 5 a light-transmitting conductive layer,

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and numeral 6 a photo-conductive layer approximately 2 microns thick consisting of a multiplicity of selenium films each about 5 A thick and CdSe films each about 20 A thick alternately deposited one on another. Reference numeral 7 shows a CdTe film with a thickness of approximately 1,000 A. In the embodiment under consideration, a rectifying contact is interposed between the photo-conductive layer 6 and the CdTe film 7. A photo-conductive layer consisting of only selenium 10 films develops no sufficient sensitivity to light of long wavelengths, while one with only CdSe films does not satisfy the requirements for rectifying contact. The employment of a multi-layer as represented by the photoconductive layer 6 consisting of alternately deposited 15 multiplicity of selenium and CdSe films makes it possible to obtain a target superior both in rectifying contact and in sensitivity to long wavelength as is apparent from Table 2.

TABLE 2 — Characteristics of Target for Image Pickup Tube According to Embodiment 2

;	target construc- tion	dark current at target voltage of 50 V	wavelength at peak spectral sensitivity	lag (after 3 fields)	after image
	selenium only CdSe only this in-	1 nA 35 nA	400 mμ 650 mμ	6% 30%	long long
	vention	2 nA	600 mu	15%	chort

In this embodiment, CdTe may be replaced by ZnS, CdS, ZnSe, CdSe or a mixture of any ones of them which has a property similar to that of CdTe.

EMBODIMENT 3

A third embodiment of the invention is shown in FIG. 5. In the figure, reference numeral 8 shows a glass substrate, numeral 9 a light-transmitting conductive layer, the numeral 10 a film of MnF₂ 200 A thick. The interposition of the insulating material MnF₂ between the light-transmitting conductive layer 9 and the selenium film 11 permits the reverse breakdown voltage of the rectifying contact between the light-transmitting conductive layer 9 and the selenium film 11 to be increased. The purpose of increasing the reverse breakdown voltage of the rectifying contact is also achieved by the interposition of PbF₂, CaF₂, MgF₂, Al₂O₃, SiO, ZnS, As₂S₃, or the like insulating material instead of MnF₂. Incidentally, the thickness of the insulating film may be in the range from 10 to 1,000 A.

The selenium film 11 which is approximately 3 microns in thickness has a central portion 12 approximately 1,000 A thick including a multiplicity of selenium films each about 20 A and tellurium films each about 12 A alternately laid one on another. There is provided on the selenium film 11 an Sb₂S₃ film 13 about 10,000 A thick to improve the landing of the scanning electron beams. Although the Sb₂S₃ film 13 may be deposited by evaporation in a vacuum of 1 × 10^{-5} Torr. or thereabouts, a porous Sb_2S_3 film deposited by evaporation in an argon gas of about 5×10^{-2} Torr. is more effective for the purpose of effective landing of electron beams. However, since an Sb₂S₃ film which is porous through its whole thickness is too high in resistance, resulting in inferior characteristics, it is desirable that a porous film of Sb₂S₃ or As₂Se₃ be laid on a solid film of Sb₂S₃ deposited by vacuum evaporation to obtain an integrated Sb₂S₃ film. In the embodiment under consideration, the central portion 12 in the form of a multi-layer is such that an improved sensitivity to red light is obtained as shown in Table 3 without adversely affecting the rectifying contact formed of the light-transmitting conductive layer 9, in- 5 sulating film 10 and the selenium film 11.

TABLE 3 — Characteristics of Target for Image Pickup Tube According to Embodiment 3

target construc- tion	dark current at target voltage of 50 V	wavelength at peak spectral sensitivity	lag (after 3 fields)	after image
only Te only	1 nA large	400 mμ	6%	long
this in- vention	l nA	600 mμ	7%	short

EMBODIMENT 4

A fourth embodiment of the invention is illustrated 20 in FIG. 6. Reference numeral 14 shows a glass substrate, numeral 15 a light-transmitting conductive layer, numeral 16 a ZnSe film approximately 500 A thick, and numeral 17 a photo-conductive layer about 3 microns thick which comprises a multiplicity of sele- 25 nium films each about 40 A and arsenic films each about 5 A alternately laid one on another. The superior rectifying contact between the ZnSe film 16 and photoconductive layer 17 is also achieved by using a ZnS or CdSe film of the same thickness in place of the ZnSe 30 film. In this embodiment, too, an insulating film may be inserted on the side of the rectifying contact of the photo-conductive layer in order to improve the breakdown voltage of the rectifying contact in the reverse direction as in the preceding embodiment. The photo- 35 conductive layer 17 is provided with a central multilayer portion 18 about 2,000 A thick comprising a multiplicity of selenium films each about 40 A, arsenic films each about 5 A and tellurium films each about 30 A which are deposited alternately one on another.

An Sb₂S₃ film 19 about 1,000 A thick is provided on the photo-conductive layer 17 to improve the landing of the scanning electron beams. According to the present embodiment, the presence of the tellurium films in proved as shown in Table 4 without adversely affecting the advantage of the rectifying contact.

TABLE 4—Characteristics of Target for Image Pickup Tube According to Embodiment 4

target construc- tion	dark current at target voltage of 50 V	wavelength at peak spectral sensitivity	lag (after 3 fields)	after image
selenium only arsenic	I nA	400 mμ	6%	long
only this in-	large			
vention	l nA	580 mμ	8%	short

It will be understood from the above explanation that, in a target for an image pickup tube with a rectifying contact, the provision of a multi-layer consisting of a multiplicity of thin films of two or more different photo-conductive types alternately deposited one on another makes it possible to control more widely the spectral sensitivity of the target without adversely affecting the other characteristics thereof. For this reason, the present invention is applied with great advan-10 tages to the construction of a target for a color television image pickup tube or the like whose requrements for spectral sensitivity are very severe.

What we claim is:

1. A photo-conductive target for an image pickup 15 tube comprising a light-transmitting substrate, a lighttransmitting conductive layer deposited on said lighttransmitting substrate and a photo-conductive layer deposited on said light-transmitting conductive layer, said photo-conductive layer containing selenium and including a portion not less than 1,000 A thick, said portion of said photo-conductive layer consisting of a multiplicity of thin films of at least two different materials with different photo-conductive characteristics, each having the thickness of 100 A or less, said thin films being laid alternately one on another.

2. A photo-conductive target for an image pickup tube according to claim 1, further comprising one semiconductor layer selected from the group consisting of ZnS, CdS, ZnSe, CdSe, CdTe and a mixture thereof deposited on said photo-conductive layer, a rectifying contact being formed by said semiconductor layer and said photo-conductive layer.

3. A photo-conductive target for an image pickup tube according to claim 1, in which said lighttransmitting layer and said photo-conductive layer constitute a rectifying contact.

4. A photo-conductive target for an image pickup tube according to claim 2, in which an insulating thin film with the thickness from 10 A to 1,000 A and comprising one selected from the group consisting of ZnS, PbF₂, MnF₂, CaF₂, MgF₂, Al₂O₃, SiO and As₂S₃ is provided adjacent to that side of said photo-conductive layer which has said rectifying contact.

5. A photo-conductive target for an image pickup the layer 18 permits the sensitivity to red light to be im- 45 tube according to claim 3, in which an insulating thin film with the thickness from 10 A to 1,000 A and comprising one selected from the group consisting of ZnS, PbF₂, MnF₂, CaF₂, MgF₂, Al₂O₃, SiO and As₂S₃ is provided adjacent to that side of said photo-conductive 50 layer which has said rectifying contact.

6. A photo-conductive target for an image pickup tube according to claim 1, in which the surface of said photo-conductive layer to be scanned by an electron beam is covered with one selected from the group con-55 sisting of a vacuum-evaporated Sb₂S₃ film, a porous Sb₂S₃ film, a combination of a vacuum-evaporated Sb₂S₃ and a porous Sb₂S₃ film, and a porous As₂Se₃ film deposited on a vacuum-evaporated Sb₂S₃ film.